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### 2.0 MHz, 500 mA Synchronous Buck Regulator

#### Features

- Over 90% Typical Efficiency
- Output Current Up To 500 mA
- Low PFM Quiescent Current = 45 μA, typical (MCP1603/L)
- Low Shutdown Current = 0.1 μA, typical
- Adjustable Output Voltage:
- 0.8V to 4.5V
- Fixed Output Voltage:
  - 1.2V, 1.5V, 1.8V, 2.5V, 3.3V (MCP1603/L)
  - 1.8V, 3.3V (MCP1603B)
- 2.0 MHz Fixed-Frequency PWM (Heavy Load)
- Automatic PWM-to-PFM Mode Transition (MCP1603/L)
- PWM Mode Only Option (MCP1603B)
- 100% Duty Cycle Operation
- Internally Compensated
- Undervoltage Lockout (UVLO)
- Overtemperature Protection
- Space Saving Packages:
  - 5-Lead TSOT, Two Pinout Types (MCP1603/L)
  - 8-Lead 2 x 3 DFN

#### **Applications**

- · Cellular Telephones
- Portable Computers
- Organizers / PDAs
- USB Powered Devices
- Digital Cameras
- Portable Equipment
- +5V or +3.3V Distributed Systems
- Headsets

#### **General Description**

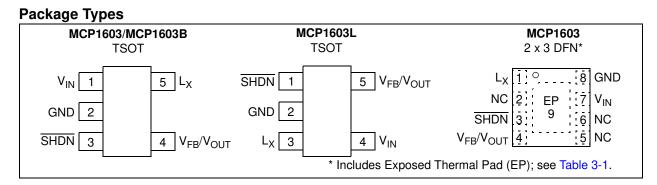
The MCP1603/B/L is a high-efficiency, fully-integrated 500 mA synchronous buck regulator whose 2.7V to 5.5V input voltage range makes it ideally suited for applications powered from 1-cell Li-lon or 2-cell/3-cell NiMH/NiCd batteries.

At heavy loads, the MCP1603/B/L operates in the 2.0 MHz fixed frequency pulse-width modulation (PWM) mode, which provides a low noise, low-output ripple, small-size solution. When the load is reduced to light levels, the MCP1603/L automatically changes operation to a Pulse Frequency Modulation (PFM) mode to minimize quiescent current draw from the battery. No intervention is necessary for a smooth transition from one mode to another. These two modes of operation allow the MCP1603/L to achieve the highest efficiency over the entire operating current range.

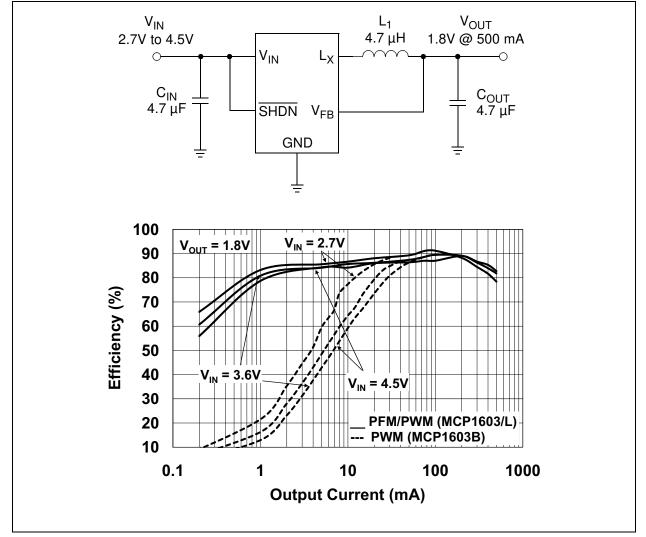
The MCP1603B device disables the PFM mode switching, and operates only in normal PWM mode over the entire load range (without skipping). MCP1603B is for applications that cannot tolerate the low-frequency output ripple associated with PFM switching.

The MCP1603/B/L family is available with either an adjustable or fixed-output voltage. The available fixed output voltage options for MCP1603/L are 1.2V, 1.5V, 1.8V, 2.5V and 3.3V, and for MCP1603B are 1.8 and 3.3V. When a fixed option is used, only three additional small external components are needed to form a complete solution. Couple this with the low profile, small-foot print packages and the entire system solution is achieved with minimal size.

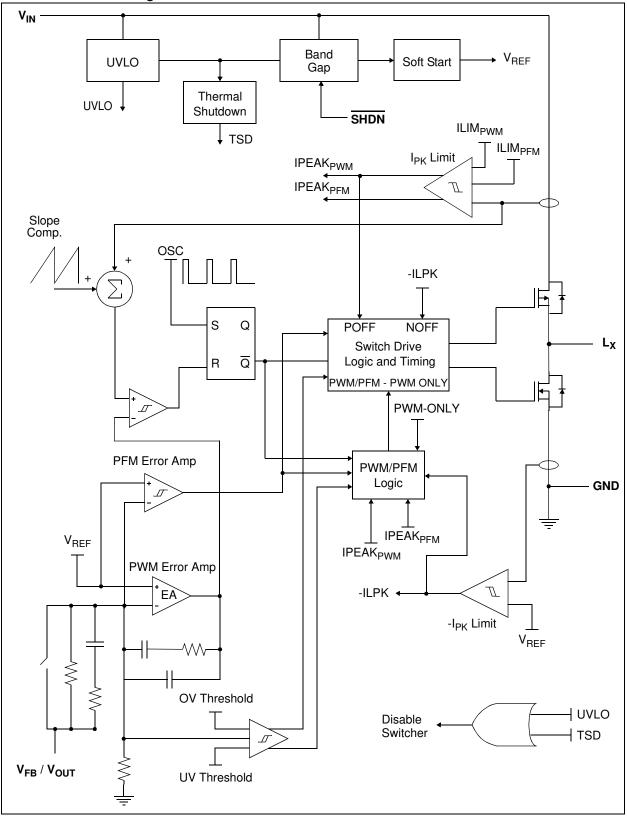
Additional protection features include: UVLO, overtemperature and overcurrent protection.



#### **Typical Application Circuit**



#### **Functional Block Diagram**



#### 1.0 ELECTRICAL CHARACTERISTICS

#### Absolute Maximum Ratings †

V <sub>IN</sub> - GND	+6.0V
All Other I/O (GND -	- 0.3V) to (V <sub>IN</sub> + 0.3V)
L <sub>X</sub> to GND	0.3V to (V <sub>IN</sub> + 0.3V)
Output Short Circuit Current	Continuous
Power Dissipation (Note 5)	Internally Limited
Storage Temperature	65°C to +150°C
Ambient Temp. with Power Applied	40°C to +85°C
Operating Junction Temperature	40°C to +125°C
ESD Protection On All Pins:	
НВМ	4 kV
MM	

**† Notice:** Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

### DC CHARACTERISTICS

**Electrical Characteristics:** Unless otherwise indicated, MCP1603/L,  $V_{IN} = \overline{SHDN} = 3.6V$ ,  $C_{OUT} = C_{IN} = 4.7 \,\mu\text{F}$ , L = 4.7  $\mu$ H,  $V_{OUT}(ADJ) = 1.8V$ ,  $I_{OUT} = 100 \text{ mA}$ ,  $T_A = +25^{\circ}\text{C}$ . **Boldface** specifications apply over the  $T_A$  range of -40°C to +85°C.

10 100 0.						
Parameters	Sym	Min	Тур	Max	Units	Conditions
Input Characteristics						
Input Voltage	V <sub>IN</sub>	2.7		5.5	V	Note 1
Maximum Output Current	I <sub>OUT</sub>	500	_		mA	Note 1
Shutdown Current	I <sub>IN_SHDN</sub>	_	0.1	1	μA	SHDN = GND
Quiescent Current - PFM	Ι <sub>Q</sub>		45	60	μA	$\overline{\text{SHDN}} = V_{\text{IN}}, I_{\text{OUT}} = 0 \text{ mA},$ device switching
Quiescent Current - PWM	Ι <sub>Q</sub>	1.0	2.7	4	mA	$\overline{\text{SHDN}} = V_{\text{IN}}, I_{\text{OUT}} = 0 \text{ mA},$ device switching ( <b>MCP1603B</b> )
Shutdown/UVLO/Thermal Shutd	own Charac	teristics				
SHDN, Logic Input Voltage Low	V <sub>IL</sub>		_	15	%V <sub>IN</sub>	V <sub>IN</sub> = 2.7V to 5.5V
SHDN, Logic Input Voltage High	V <sub>IH</sub>	45	_		%V <sub>IN</sub>	V <sub>IN</sub> = 2.7V to 5.5V
SHDN, Input Leakage Current	IL_SHDN	-1.0	±0.1	1.0	μA	V <sub>IN</sub> = 2.7V to 5.5V
Undervoltage Lockout	UVLO	2.12	2.28	2.43	V	V <sub>IN</sub> Falling
Undervoltage Lockout Hysteresis	UVLO <sub>HYS</sub>	_	140	_	mV	
Thermal Shutdown	T <sub>SHD</sub>	_	150		°C	Note 4, Note 5
Thermal Shutdown Hysteresis	T <sub>SHD-HYS</sub>	_	10	_	°C	Note 4, Note 5

**Note 1:** The input voltage should be greater then the output voltage plus headroom voltage; higher load currents increase the input voltage required for regulation. MCP1603B device requires a minimum load for regulation. See **Section 2.0, Typical Performance Curves** for typical operating voltage ranges.

2: Reference Feedback Voltage Tolerance applies to adjustable output voltage setting.

- **3:** V<sub>R</sub> is the output voltage setting.
- **4:** The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable temperature and the thermal resistance from junction to air (i.e. T<sub>A</sub>, T<sub>J</sub>, θ<sub>JA</sub>). Exceeding the maximum allowable power dissipation causes the device to initiate thermal shutdown.
- 5: The internal MOSFET switches have an integral diode from the L<sub>X</sub> pin to the V<sub>IN</sub> pin, and from the L<sub>X</sub> pin to the GND pin. In cases where these diodes are forward-biased, the package power dissipation limits must be adhered to. Thermal protection is not able to limit the junction temperature for these cases.
- 6: The current limit threshold is a cycle-by-cycle peak current limit.

### **DC CHARACTERISTICS (CONTINUED)**

**Electrical Characteristics:** Unless otherwise indicated, MCP1603/L,  $V_{IN} = \overline{SHDN} = 3.6V$ ,  $C_{OUT} = C_{IN} = 4.7 \,\mu$ F, L = 4.7  $\mu$ H,  $V_{OUT}(ADJ) = 1.8V$ ,  $I_{OUT} = 100 \,\text{mA}$ ,  $T_A = +25^{\circ}$ C. **Boldface** specifications apply over the  $T_A$  range of -40°C to +85°C.

Parameters	Sym	Min	Тур	Max	Units	Conditions		
Output Characteristics	Dutput Characteristics							
Adjustable Output Voltage Range	V <sub>OUT</sub>	0.8		4.5	V	Note 2		
Reference Feedback Voltage	V <sub>FB</sub>		0.8	_	V			
Reference Feedback Voltage		-3.0	—	+3.0	%	$T_A = -40^{\circ}C \text{ to } +25^{\circ}C$		
Tolerance		-2.5	—	+2.5	%	$T_A = +25^{\circ}C \text{ to } +85^{\circ}C$		
Feedback Input Bias Current	I <sub>VFB</sub>	—	0.1		nA			
Output Voltage Tolerance Fixed	V <sub>OUT</sub>	-3.0%	V <sub>R</sub>	+3.0%	%	$T_A = -40^{\circ}C$ to $+25^{\circ}C$ , Note 3		
	V <sub>OUT</sub>	-2.5	V <sub>R</sub>	+2.5	%	T <sub>A</sub> = +25°C to +85°C, <b>Note 3</b>		
Line Regulation	V <sub>LINE-REG</sub>	_	0.3		%/V	$V_{IN} = V_R + 1V$ to 5.5V, $I_{OUT} = 100$ mA		
Load Regulation	V <sub>LOAD-REG</sub>	—	0.35		%	V <sub>IN</sub> = V <sub>R</sub> +1.5V, I <sub>LOAD</sub> = 100 mA to 500 mA		
Internal Oscillator Frequency	F <sub>OSC</sub>	1.5	2.0	2.8	MHz			
Start Up Time	T <sub>SS</sub>	—	0.6	_	ms	T <sub>R</sub> = 10% to 90%		
R <sub>DSon</sub> P-Channel	R <sub>DSon-P</sub>	—	500		mΩ	I <sub>P</sub> = 100 mA		
R <sub>DSon</sub> N-Channel	R <sub>DSon-N</sub>	—	500		mΩ	I <sub>N</sub> = 100 mA		
L <sub>X</sub> Pin Leakage Current	I <sub>LX</sub>	-1.0	±0.1	1.0	μA	$\overline{SHDN} = 0V, V_{IN} = 5.5V, \\ L_X = 0V, L_X = 5.5V$		
Positive Current Limit Threshold	+I <sub>LX(MAX)</sub>	_	860		mA	Note 6		

**Note 1:** The input voltage should be greater then the output voltage plus headroom voltage; higher load currents increase the input voltage required for regulation. MCP1603B device requires a minimum load for regulation. See Section 2.0, Typical Performance Curves for typical operating voltage ranges.

2: Reference Feedback Voltage Tolerance applies to adjustable output voltage setting.

- **3:** V<sub>R</sub> is the output voltage setting.
- **4:** The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable temperature and the thermal resistance from junction to air (i.e. T<sub>A</sub>, T<sub>J</sub>, θ<sub>JA</sub>). Exceeding the maximum allowable power dissipation causes the device to initiate thermal shutdown.
- 5: The internal MOSFET switches have an integral diode from the L<sub>X</sub> pin to the V<sub>IN</sub> pin, and from the L<sub>X</sub> pin to the GND pin. In cases where these diodes are forward-biased, the package power dissipation limits must be adhered to. Thermal protection is not able to limit the junction temperature for these cases.
- 6: The current limit threshold is a cycle-by-cycle peak current limit.

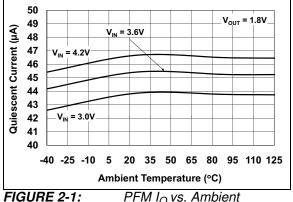
### **TEMPERATURE SPECIFICATIONS**

Electrical Specifications: Unless otherwise indicated, all limits are specified for: V <sub>IN</sub> + 2.7V to 5.5V						
Parameters		Min	Тур	Max	Units	Conditions
Temperature Ranges						
Operating Junction Temperature Range	ТJ	-40	_	+125	°C	Steady State
Storage Temperature Range	T <sub>A</sub>	-65	—	+150	°C	
Maximum Junction Temperature	ТJ		—	+150	°C	Transient
Package Thermal Resistances						
Thermal Resistance, 5L-TSOT	$\theta_{JA}$	—	207.4	—	°C/W	Typical 4-layer Board with Internal Ground Plane
Thermal Resistance, 8L-2x3 DFN	θ <sub>JA</sub>	—	68	_	°C/W	Typical 4-layer Board with Internal Ground Plane and 2-Vias in Thermal Pad

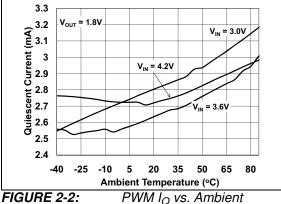
#### 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

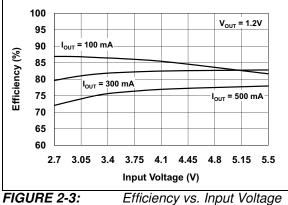
**Note:** Unless otherwise indicated, MCP1603/L,  $V_{IN} = \overline{SHDN} = 3.6V$ ,  $C_{OUT} = C_{IN} = 4.7 \,\mu\text{F}$ ,  $L = 4.7 \,\mu\text{H}$ ,  $V_{OUT}(ADJ) = 1.8V$ ,  $I_{LOAD} = 100 \,\text{mA}$ ,  $T_A = +25^{\circ}\text{C}$ . Adjustable or fixed output voltage options can be used to generate the Typical Performance Characteristics.



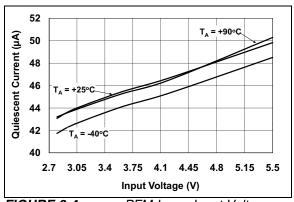




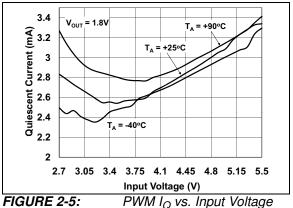
Temperature (**MCP1603B**).



**FIGURE 2-3:** Efficiency vs. Input Volta  $(V_{OUT} = 1.2V)$ .

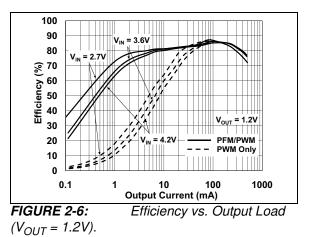


**FIGURE 2-4:** PFM I<sub>Q</sub> vs. Input Voltage (**MCP1603/L**).

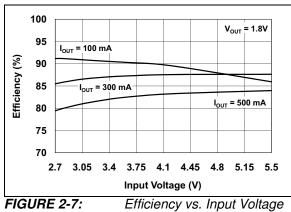


(MCP1603B).





**Note:** Unless otherwise indicated, MCP1603/L,  $V_{IN} = \overline{SHDN} = 3.6V$ ,  $C_{OUT} = C_{IN} = 4.7 \,\mu\text{F}$ ,  $L = 4.7 \,\mu\text{H}$ ,  $V_{OUT}(ADJ) = 1.8V$ ,  $I_{LOAD} = 100 \,\text{mA}$ ,  $T_A = +25^{\circ}\text{C}$ . Adjustable or fixed output voltage options can be used to generate the Typical Performance Characteristics.



 $(V_{OUT} = 1.8V).$ 

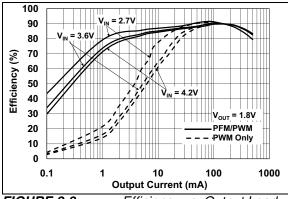
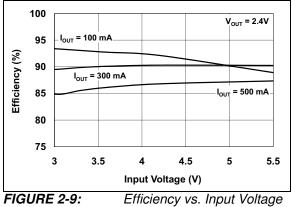
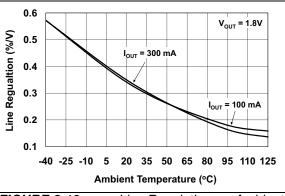


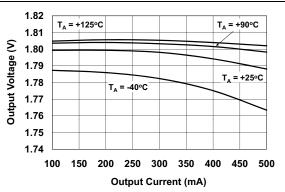
FIGURE 2-8: Efficiency vs. Output Load (V<sub>OUT</sub> = 1.8V).

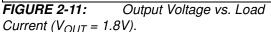


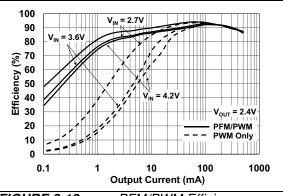
 $(V_{OUT} = 2.4V).$ 



**FIGURE 2-10:** Line Regulation vs. Ambient Temperature (V<sub>OUT</sub> = 1.8V).

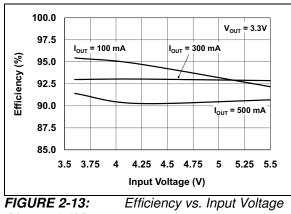




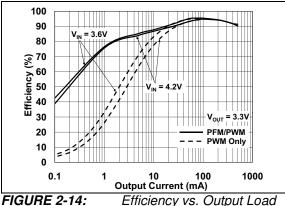


**FIGURE 2-12:** PFM/PWM Efficiency vs. Output Load ( $V_{OUT} = 2.4V$ ).

**Note:** Unless otherwise indicated, MCP1603/L,  $V_{IN} = \overline{SHDN} = 3.6V$ ,  $C_{OUT} = C_{IN} = 4.7 \,\mu\text{F}$ ,  $L = 4.7 \,\mu\text{H}$ ,  $V_{OUT}(ADJ) = 1.8V$ ,  $I_{LOAD} = 100 \,\text{mA}$ ,  $T_A = +25^{\circ}\text{C}$ . Adjustable or fixed output voltage options can be used to generate the Typical Performance Characteristics.



 $(V_{OUT} = 3.3V).$ 



 $(V_{OUT} = 3.3V).$ 

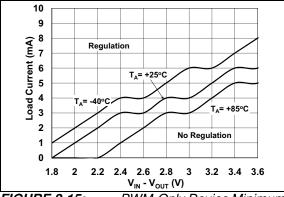
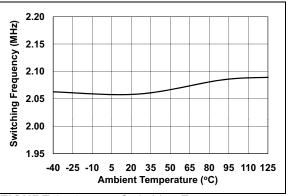


FIGURE 2-15: PWM-Only Device Minimum Load for Regulation (MCP1603B).



**FIGURE 2-16:** Switching Frequency vs. Ambient Temperature.

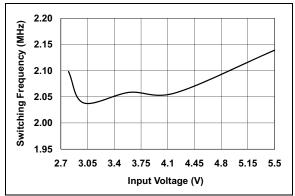
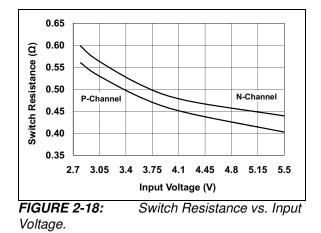
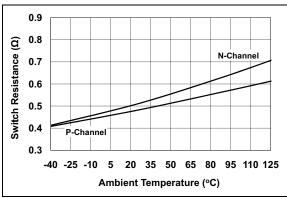


FIGURE 2-17: Switching Frequency vs. Input Voltage.



**Note:** Unless otherwise indicated, MCP1603/L,  $V_{IN} = \overline{SHDN} = 3.6V$ ,  $C_{OUT} = C_{IN} = 4.7 \,\mu\text{F}$ ,  $L = 4.7 \,\mu\text{H}$ ,  $V_{OUT}(ADJ) = 1.8V$ ,  $I_{LOAD} = 100 \,\text{mA}$ ,  $T_A = +25^{\circ}\text{C}$ . Adjustable or fixed output voltage options can be used to generate the Typical Performance Characteristics.



*FIGURE 2-19:* Switch Resistance vs. Ambient Temperature.

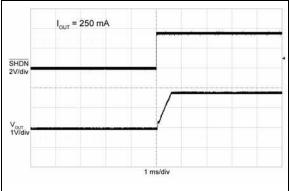


FIGURE 2-20: Output Voltage Startup Waveform.

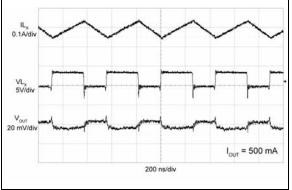


FIGURE 2-21: Heavy Load Switching Waveform.

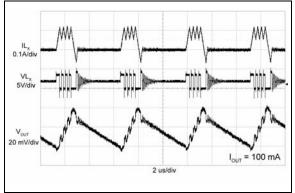


FIGURE 2-22: PFM Light Load Switching Waveforms (MCP1603/L).

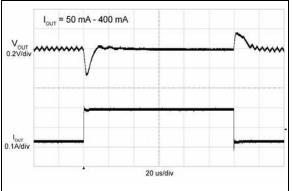
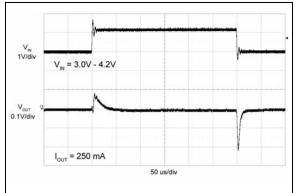


FIGURE 2-23: Output Voltage Load Step Response vs. Time.



**FIGURE 2-24:** Output Voltage Line Step Response vs. Time.

**Note:** Unless otherwise indicated, MCP1603/L,  $V_{IN} = \overline{SHDN} = 3.6V$ ,  $C_{OUT} = C_{IN} = 4.7 \,\mu\text{F}$ ,  $L = 4.7 \,\mu\text{H}$ ,  $V_{OUT}(ADJ) = 1.8V$ ,  $I_{LOAD} = 100 \,\text{mA}$ ,  $T_A = +25^{\circ}\text{C}$ . Adjustable or fixed output voltage options can be used to generate the Typical Performance Characteristics.

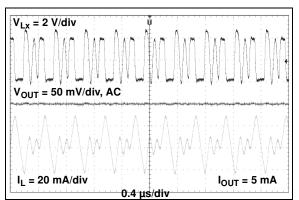


FIGURE 2-25: PWM Light Load Switching Waveforms (MCP1603B).

#### 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

<b>IABLE 3-1:</b>		CTION TABI	_E	
MCP1603/B TSOT-23	MCP1603L TSOT-23	<b>MCP1603</b> 2 x 3 DFN	Symbol	Description
1	4	7	V <sub>IN</sub>	Power Supply Input Voltage Pin
2	2	8	GND	Ground Pin
3	1	3	SHDN	Shutdown Control Input Pin
4	5	4	V <sub>FB</sub> /V <sub>OUT</sub>	Feedback / Output Voltage Pin
5	3	1	L <sub>X</sub>	Switch Node, Buck Inductor Connection Pin
—	—	2, 5, 6	NC	No Connect
_		Exposed Pad	EP	For the DFN package, the center exposed pad is a thermal path to remove heat from the device. Electrically, this pad is at ground potential and should be connected to GND.

#### TABLE 3-1: PIN FUNCTION TABLE

#### 3.1 Power Supply Input Voltage Pin (V<sub>IN</sub>)

Connect the input voltage source to  $V_{\text{IN}}.$  The input source must be decoupled to GND with a 4.7  $\mu\text{F}$  capacitor.

#### 3.2 Ground Pin (GND)

Ground pin for the device. The loop area of the ground traces should be kept as minimal as possible.

#### 3.3 <u>Shutdown Control Input Pin</u> (SHDN)

The  $\overline{SHDN}$  pin is a logic-level input used to enable or disable the device. A logic high (>45% of V\_{IN}) will enable the regulator output. A logic low (<15% of V\_{IN}) will ensure that the regulator is disabled.

#### 3.4 Feedback / Output Voltage Pin (V<sub>FB</sub>/V<sub>OUT</sub>)

For adjustable output options, connect the center of the output voltage divider to the  $V_{FB}/V_{OUT}$  pin. For fixed-output voltage options, connect the output directly to the  $V_{FB}/V_{OUT}$  pin.

#### 3.5 Switch Node, Buck Inductor Connection Pin (L<sub>X</sub>)

Connect the  $L_X$  pin directly to the buck inductor. This pin carries large signal-level current; all connections should be made as short as possible.

#### 3.6 Exposed Metal Pad (EP)

For the DFN package, connect the Exposed Pad to GND, with vias into the GND plane. This connection to the GND plane will aid in heat removal from the package.

#### 4.0 DETAILED DESCRIPTION

#### 4.1 Device Overview

The MCP1603/L is a synchronous buck regulator that operates in a Pulse Frequency Modulation (PFM) mode or a Pulse Width Modulation (PWM) mode to maximize system efficiency over the entire operating current range. Capable of operating from a 2.7V to 5.5V input voltage source, the MCP1603 can deliver 500 mA of continuous output current.

The MCP1603B device disables the PFM mode switching, and operates only in normal PWM mode.

When using the MCP1603/B/L, the PCB area required for a complete step-down converter is minimized, since both the main P-Channel MOSFET and the synchronous N-Channel MOSFET are integrated. Also while in PWM mode, the device switches at a constant frequency of 2.0 MHz (typical), which allows for small filtering components. Both fixed and adjustable output voltage options are available. The fixed voltage options (1.2V, 1.5V 1.8V, 2.5V, 3.3V) do not require an external voltage divider, which further reduces the required circuit board footprint. The adjustable output voltage options allow for more flexibility in the design, but require an external voltage divider.

Additionally, the device features an undervoltage lockout (UVLO), overtemperature shutdown, overcurrent protection and enable/disable control.

#### 4.2 Synchronous Buck Regulator

The MCP1603/L has two distinct modes of operation that allow the device to maintain a high level of efficiency throughout the entire operating current and voltage range. The device automatically switches between PWM mode and PFM mode, depending on the output load requirements. MCP1603B switches in PWM mode only.

### 4.2.1 PFM/PWM MODE DEVICE OPTION (MCP1603/L)

During heavy load conditions, the MCP1603/L operates at a high, fixed switching frequency of 2.0 MHz (typical) using current mode control. This minimizes output ripple (10 - 15 mV, typically) and noise, while maintaining high efficiency (88% typical with V<sub>IN</sub> = 3.6V, V<sub>OUT</sub> = 1.8V, I<sub>OUT</sub> = 300 mA).

During normal PWM operation, the beginning of a switching cycle occurs when the internal P-Channel MOSFET is turned on. The ramping inductor current is sensed and tied to one input of the internal high-speed comparator. The other input to the high-speed comparator is the error amplifier output. This is the difference between the internal 0.8V reference and the divided-down output voltage. When the sensed current becomes equal to the amplified error signal, the high-speed comparator switches states and the P-Channel MOSFET is turned off. The N-Channel MOSFET is turned off. The N-Channel MOSFET is turned on until the internal oscillator sets an internal RS latch, initiating the beginning of another switching cycle.

PFM-to-PWM mode transition is initiated for any of the following conditions:

- Continuous device switching
- Output voltage has dropped out of regulation

#### 4.2.1.1 Light Load, PFM Mode

During light-load conditions, the MCP1603/L operates in a PFM mode. When the MCP1603/L enters this mode, it begins to skip pulses to minimize unnecessary quiescent-current draw by reducing the number of switching cycles per second. The typical quiescent current draw for this device is  $45 \ \mu$ A.

PWM-to-PFM mode transition is initiated for any of the following conditions:

- Discontinuous inductor current is sensed for a set duration
- Inductor peak current falls below the transition threshold limit

### 4.2.2 PWM MODE DEVICE OPTION (MCP1603B)

There are applications that cannot tolerate the low frequency pulse skipping mode or the output ripple voltage associated with it, which is distinctive for PFM switching.

The MCP1603B device has disabled the PFM mode switching. It operates only in normal PWM mode over the entire load range (without skipping pulses). During periods of light load operation, the MCP1603B continues to operate at a constant 2 MHz switching frequency, keeping the output ripple voltage lower than PFM mode. Because there are no skipping pulses, a minimum load current is necessary to keep output in regulation (see Figure 2-15, without a minimum load, the output voltage will be greater than the set point). The minimum load value depends on the input-tooutput ratio.

#### 4.3 Soft Start

The output of the MCP1603 is controlled during startup. This control allows for a very minimal amount of  $V_{OUT}$  overshoot during start-up from  $V_{IN}$  rising above the UVLO voltage or SHDN being enabled.

#### 4.4 Overtemperature Protection

Overtemperature protection circuitry is integrated in the MCP1603/B/L device family. This circuitry monitors the device junction temperature and shuts the device off, if the junction temperature exceeds the typical +150°C threshold. If this threshold is exceeded, the device will automatically restart once the junction temperature drops by approximately 10°C. The soft start is reset during an overtemperture condition.

#### 4.5 Overcurrent Protection

Cycle-by-cycle current limiting is used to protect the MCP1603/B/L device family from being damaged when an external short circuit is applied. The typical peak current limit is 860 mA. If the sensed current reaches the 860 mA limit, the P-Channel MOSFET is turned off, even if the output voltage is not in regulation. The device will attempt to start a new switching cycle when the internal oscillator sets the internal RS latch.

#### 4.6 Enable/Disable Control

The SHDN pin is used to enable or disable the MCP1603/B/L. When the SHDN pin is pulled low, the device is disabled. When pulled high, the device is enabled and begins operation, unless the input voltage is below the UVLO threshold or a fault condition exists.

#### 4.7 Undervoltage Lockout (UVLO)

The UVLO feature uses a comparator to sense the input voltage (V<sub>IN</sub>) level. If the input voltage is lower than the voltage necessary to properly operate the MCP1603, the UVLO feature will hold the converter off. When V<sub>IN</sub> rises above the necessary input voltage, the UVLO is released and soft start begins. Hysteresis is built into the UVLO circuit to compensate for input impedance. For example, if there is any resistance between the input voltage source and the device when it is operating, there will be a voltage drop at the input to the device equal to I<sub>IN</sub> x R<sub>IN</sub>. The typical hysteresis is 140 mV.

#### 5.0 APPLICATION INFORMATION

#### 5.1 Typical Applications

The MCP1603/B/L 500 mA synchronous buck regulator operates over a wide input voltage range (2.7V to 5.5V) and is ideal for single-cell Li-Ion battery-powered applications, USB-powered applications, three cell NiMH or NiCd applications and 3V or 5V regulated input applications. The 5-lead TSOT and 8-lead 2 x 3 DFN packages provide a small footprint with minimal external components.

#### 5.2 Fixed Output Voltage Applications

The **Typical Application Circuit** shows a fixed MCP1603/B/L in an application used to convert three NiMH batteries into a well-regulated 1.8V @ 500 mA output. A 4.7  $\mu$ F input capacitor, 4.7  $\mu$ F output capacitor, and a 4.7  $\mu$ H inductor make up the entire external component solution for this application. No external voltage divider or compensation is necessary. In addition to the fixed 1.8V option, the MCP1603 is also available in 1.2V, 1.5V, 2.5V, or 3.3V fixed voltage options.

#### 5.3 Adjustable Output Voltage Applications

When the desired output for a particular application is not covered by the fixed-voltage options, an adjustable MCP1603/B/L can be used. The circuit listed in Figure 6-2 shows an adjustable device being used to convert a 5V rail to 1.0V @ 500 mA. The output voltage is adjustable by using two external resistors as a voltage divider. For adjustable-output voltages, it is recommended that the top resistor divider value be 200 k $\Omega$ . The bottom resistor value can be calculated using the following equation:

#### EQUATION 5-1:

$$\begin{split} R_{BOT} &= R_{TOP} \times \left( \frac{V_{FB}}{V_{OUT} - V_{FB}} \right) \\ \text{Example:} \\ \text{R}_{TOP} &= 200 \text{ k}\Omega \\ \text{V}_{OUT} &= 1.0\text{V} \\ \text{V}_{FB} &= 0.8\text{V} \\ \text{R}_{BOT} &= 200 \text{ k}\Omega \times (0.8\text{V}/(1.0\text{V} - 0.8\text{V})) \\ \text{R}_{BOT} &= 800 \text{ k}\Omega \text{ (Standard Value} = 787 \text{ k}\Omega) \end{split}$$

For adjustable output applications, an additional R-C compensation network is necessary for control loop stability. Recommended values for any output voltage are:

$$R_{COMP} = 4.99 \text{ k}\Omega$$

Refer to Figure 6-2 for proper placement of  $R_{COMP}$  and  $C_{COMP}$ 

#### 5.4 Input Capacitor Selection

The input current to a buck converter, when operating in Continuous Conduction mode, is a squarewave with a duty cycle defined by the output voltage ( $V_{OUT}$ ) to input voltage ( $V_{IN}$ ) relationship of  $V_{OUT}/V_{IN}$ . To prevent undesirable input voltage transients, the input capacitor should be a low-ESR type with an RMS current rating given by Equation 5.5. Because of their small size and low ESR, ceramic capacitors are often used. Ceramic material X5R or X7R are well suited, since they have a low-temperature coefficient and acceptable ESR.

#### **EQUATION 5-2:**

$$I_{CIN,RMS} = I_{OUT,MAX} \times \left( \sqrt{\frac{V_{OUT} \times (V_{IN} - V_{OUT})}{V_{IN}}} \right)$$

 Table 5-1 contains the recommend range for the input capacitor value.

#### 5.5 Output Capacitor Selection

The output capacitor helps provide a stable output voltage during sudden load transients, smooths the current that flows from the inductor to the load, and reduces the output voltage ripple. Therefore, low-ESR capacitors are a desirable choice for the output capacitor. As with the input capacitor, X5R and X7R ceramic capacitors are well suited for this application.

The output ripple voltage is often a design specification. A buck converters' output ripple voltage is a function of the charging and discharging of the output capacitor and the ESR of the capacitor. This ripple voltage can be calculated by Equation 5-3.

#### **EQUATION 5-3:**

$$\Delta V_{OUT} = \Delta I_L \times ESR + \frac{\Delta I_L}{8 \times f \times C}$$

 Table 5-1 contains the recommend range for the output capacitor value.

TABLE 5-1:CAPACITOR VALUE RANGE

	C <sub>IN</sub>	C <sub>OUT</sub>
Minimum	4.7 μF	4.7 μF
Maximum		22 μF

#### 5.6 Inductor Selection

When using the MCP1603, the inductance value can range from 3.3 µH to 10 µH. An inductance value of 4.7 µH is recommended to achieve a good balance between converter load transient response and minimized noise.

The value of inductance is selected to achieve a desired amount of ripple current. It is reasonable to assume a ripple current that is 20% of the maximum load current. The larger the amount of ripple current allowed, the larger the output capacitor value becomes to meet ripple voltage specifications. The inductor ripple current can be calculated according to the following equation.

**EQUATION 5-4:** 

$$\Delta I_L = \frac{V_{OUT}}{F_{SW} \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$
Where:

W

F<sub>SW</sub> = Switching Frequency

When considering inductor ratings, the maximum DC current rating of the inductor should be at least equal to the maximum load current, plus one half the peak-topeak inductor ripple current  $(1/2 \times \Delta I_I)$ . The inductor DC resistance adds to the total converter power loss. An inductor with a low DC resistance allows for higher converter efficiency.

TABLE 5-2:	MCP1603 RECOMMENDED
	INDUCTORS

Part Number	Value (µH)	DCR Ω (max)	I <sub>SAT</sub> (A)	Size WxLxH (mm)	
Coiltronics	®				
SD3110	3.3	0.195	0.81	3.1x3.1x1.0	
SD3110	4.7	0.285	0.68	3.1x3.1x1.0	
SD3110	6.8	0.346	0.58	3.1x3.1x1.0	
SD3812	3.3	0.159	1.40	3.8x3.8x1.2	
SD3812	4.7	0.256	1.13	3.8x3.8x1.2	
SD3812	6.8	0.299	0.95	3.8x3.8x1.2	
Würth Elek	tronik <sup>®</sup>				
WE-TPC Type XS	3.3	0.225	0.72	3.3x3.5x0.95	
WE-TPC Type XS	4.7	0.290	0.50	3.3x3.5x0.95	
WE-TPC Type S	4.7	0.105	0.90	3.8x3.8x1.65	
WE-TPC Type S	6.8	0.156	0.75	3.8x3.8x1.65	
WE-TPC Type Tiny	4.7	0.100	1.7	2.8x2.8x2.8	

#### **TABLE 5-2:** MCP1603 RECOMMENDED **INDUCTORS (CONTINUED)**

Part Number	Value (µH)	DCR Ω (max)	I <sub>SAT</sub> (A)	Size WxLxH (mm)
Sumida <sup>®</sup>				
CMD4D06	3.3	0.174	0.77	3.5x4.3x0.8
CMD4D06	4.7	0.216	0.75	3.5x4.3x0.8
CMD4D06	6.8	0.296	0.62	3.5x4.3x0.8
Coilcraft <sup>®</sup>				
XFL3012- 332ME_	3.3	0.106	1.2	3x3x1.2
XFL3012- 472ME_	4.7	0.143	1.0	3x3x1.2
LPS4018- 103ML_	10	0.200	1.2	4x4x1.8
TDK-EPC <sup>®</sup>				
B82462_ G4472M	4.7	0.04	1.8	6x6x3
VLS3015E T-4R7M	4.7	0.113	1.1	3x3x1.5

#### 5.7 Thermal Calculations

The MCP1603 is available in two different packages (TSOT-23 and 2x3 DFN). The junction temperature is estimated by calculating the power dissipation and applying the package thermal resistance ( $\theta_{IA}$ ). The maximum continuous junction temperature rating for the MCP1603 is +125°C.

To quickly estimate the internal power dissipation for the switching buck regulator, an empirical calculation using measured efficiency can be used. Given the measured efficiency, the internal power dissipation is estimated by the following equation:

#### **EQUATION 5-5:**

$$\left(\frac{V_{OUT} \times I_{OUT}}{Efficiency}\right) - (V_{OUT} \times I_{OUT}) = P_{Diss}$$

The difference between the first term, input power dissipation, and the second term, power delivered, is the internal power dissipation. This is an estimate assuming that most of the power lost is internal to the MCP1603. There is some percentage of power lost in the buck inductor, with very little loss in the input and output capacitors.

#### 5.8 PCB Layout Information

Good printed circuit board layout techniques are important to any switching circuitry, and switching power supplies are no different. When wiring the highcurrent paths, short and wide traces should be used. This high-current path is shown with red connections in Figure 5-1. The current in this path is switching. Therefore, it is important that the components along the high-current path should be placed as close as possible to the MCP1603 to minimize the loop area.

The feedback resistors and feedback signal should be routed away from the switching node and this switching current loop. When possible, ground planes and traces should be used to help shield the feedback signal and minimize noise and magnetic interference.

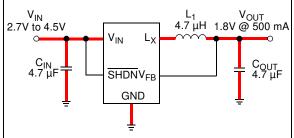


FIGURE 5-1:

PCB High Current Path.

#### 6.0 **TYPICAL APPLICATION CIRCUITS**

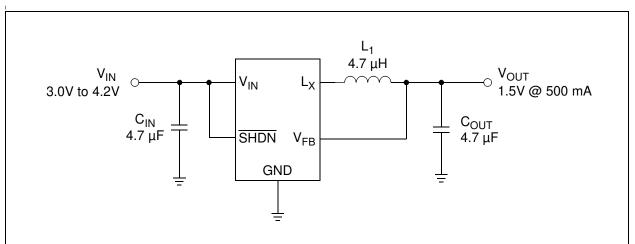
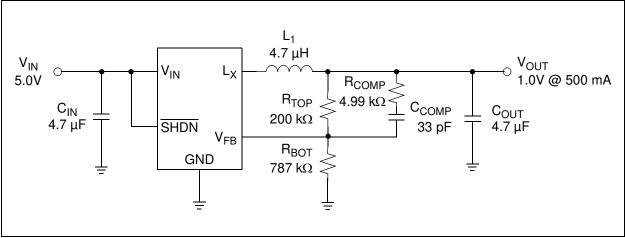
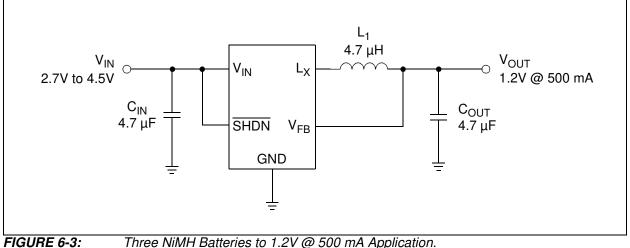


FIGURE 6-1: Single Li-Ion to 1.5V @ 500 mA Application.



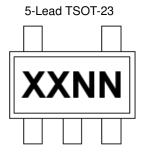
5V to 1.0V @ 500 mA Application. FIGURE 6-2:



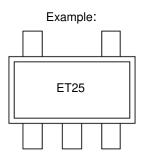
Three NiMH Batteries to 1.2V @ 500 mA Application.

### 7.0 PACKAGING INFORMATION

#### 7.1 Package Marking Information



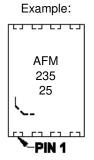
Part Number	Code
MCP1603T-120I/OS	ETNN
MCP1603T-150I/OS	EUNN
MCP1603T-180I/OS	EVNN
MCP1603T-250I/OS	EWNN
MCP1603T-330I/OS	EXNN
MCP1603T-ADJI/OS	EYNN
MCP1603BT-180I/OS	GBNN
MCP1603BT-330I/OS	GENN
MCP1603BT-ADJI/OS	GANN
MCP1603LT-120I/OS	FMNN
MCP1603LT-150I/OS	FKNN
MCP1603LT-180I/OS	EJNN
MCP1603LT-250I/OS	FGNN
MCP1603LT-330I/OS	FANN
MCP1603LT-ADJI/OS	FQNN



#### 8-Lead 2x3 DFN



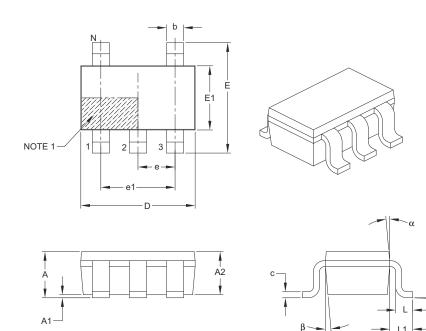
Part Number	Code
MCP1603-120I/MC	AFM
MCP1603T-120I/MC	AFM
MCP1603-150I/MC	AFK
MCP1603T-150I/MC	AFK
MCP1603-180I/MC	AFJ
MCP1603T-180I/MC	AFJ
MCP1603-250I/MC	AFG
MCP1603T-250I/MC	AFG
MCP1603-330I/MC	AFA
MCP1603T-330I/MC	AFA
MCP1603-ADJI/MC	AFQ
MCP1603T-ADJI/MC	AFQ



Legend	: XXX Y YY WW NNN @3 *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
Note:	be carrie	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.

#### 5-Lead Plastic Thin Small Outline Transistor (OS) [TSOT]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX		
Number of Leads	Ν	5				
Lead Pitch	е	0.95 BSC				
Outside Lead Pitch	e1	1.90 BSC				
Overall Height	А	_	-	1.10		
Molded Package Thickness	A2	0.70	0.90	1.00		
Standoff	A1	0.00	-	0.10		
Overall Width	E	2.80 BSC				
Molded Package Width	E1	1.60 BSC				
Overall Length	D	2.90 BSC				
Foot Length	L	0.30	0.45	0.60		
Footprint	L1	0.60 REF				
Foot Angle	φ	0°	4°	8°		
Lead Thickness	С	0.08	_	0.20		
Lead Width	b	0.30	_	0.50		
Mold Draft Angle Top	α	4°	10°	12°		
Mold Draft Angle Bottom	β	4°	10°	12°		

#### Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.

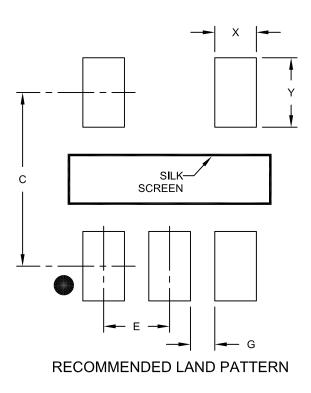
- 3. Dimensioning and tolerancing per ASME Y14.5M.
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-128B

#### 5-Lead Plastic Thin Small Outline Transistor (OS) [TSOT]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.95 BSC		
Contact Pad Spacing	С		2.80	
Contact Pad Width (X5)	X			0.60
Contact Pad Length (X5)	Y			1.10
Distance Between Pads	G	0.35		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2128A